

Thyristor Low Power Use

> REJ03G0347-0100 Rev.1.00 Aug.20.2004

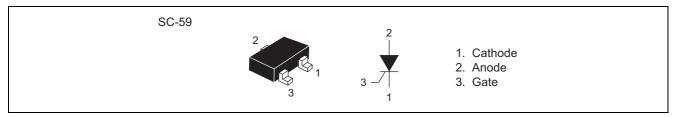
### Features

- $I_{T(AV)}: 0.1 A$
- V<sub>DRM</sub> : 400 V
- I<sub>GT</sub> : 100 μA

# • Non-Insulated Type

• Planar Passivation Type

## Outline



# Applications

Strobe flasher

### **Maximum Ratings**

Parameter	Symbol	Voltage class	Unit	
Parameter	Symbol	8	Onit	
Repetitive peak reverse voltage	V <sub>RRM</sub>	400	V	
Non-repetitive peak reverse voltage	V <sub>RSM</sub>	500	V	
DC reverse voltage	V <sub>R(DC)</sub>	320	V	
Repetitive peak off-state voltage <sup>Note1</sup>	V <sub>DRM</sub>	400	V	
DC off-state voltage <sup>Note1</sup>	V <sub>D(DC)</sub>	320	V	

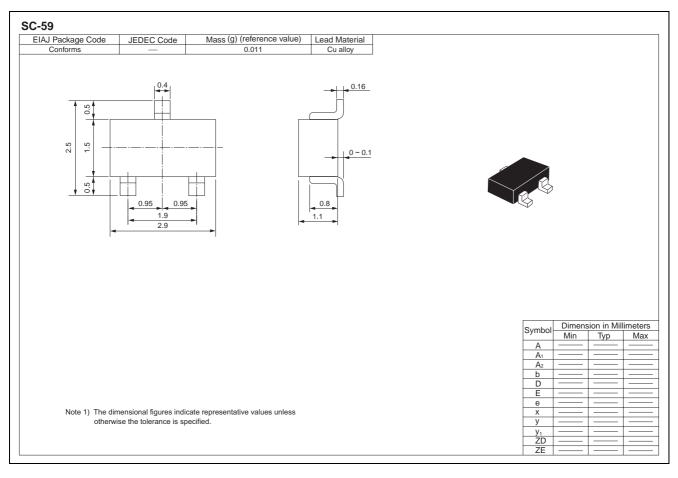
Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I <sub>T (RMS)</sub>	0.15	А	
Average on-state current	I <sub>T (AV)</sub>	0.1	A	Commercial frequency, sine half wave 180° conduction, Ta = 55°C
Surge on-state current	I <sub>TSM</sub>	10	A	60Hz sine half wave 1 full cycle, peak value, non-repetitive
l <sup>2</sup> t for fusing	l <sup>2</sup> t	0.4	A <sup>2</sup> s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P <sub>GM</sub>	0.1	W	
Average gate power dissipation	P <sub>G (AV)</sub>	0.01	W	
Peak gate forward voltage	V <sub>FGM</sub>	6	V	
Peak gate reverse voltage	V <sub>RGM</sub>	6	V	
Peak gate forward current	I <sub>FGM</sub>	0.1	А	
Junction temperature	Tj	- 40 to +125	°C	
Storage temperature	Tstg	- 40 to +125	°C	
Mass	—	11	mg	Typical value

Notes: 1. With gate to cathode resistance  $R_{GK} = 1 \text{ k}\Omega$ .

# **Electrical Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak reverse current	I <sub>RRM</sub>	—	—	0.1	mA	Tj = 125°C, V <sub>RRM</sub> applied
Repetitive peak off-state current	I <sub>DRM</sub>	—	—	0.1	mA	Tj = 125°C, V <sub>DRM</sub> applied, R <sub>GK</sub> = 1 k $\Omega$
On-state voltage	V <sub>TM</sub>	—	—	1.9	V	Ta = 25°C, $I_{TM}$ = 1.5 A, instantaneous value
Gate trigger voltage	$V_{GT}$	—	-	0.8	V	$Tj = 25^{\circ}C, V_{D} = 6 V, I_{T} = 0.1 A$
Gate non-trigger voltage	$V_{GD}$	0.2	—	_	V	$\label{eq:transform} \begin{array}{l} Tj = 125^{\circ}C,  V_{D} = 1/2  V_{DRM}, \\ R_{GK} = 1  k\Omega \end{array}$
Gate trigger current	I <sub>GT</sub>	20	_	100	μΑ	$Tj = 25^{\circ}C, V_{D} = 6 V, I_{T} = 0.1 A$
Holding current	Ι <sub>Η</sub>	—	—	3.0	mA	$\label{eq:constraint} \begin{array}{l} Tj=25^{\circ}C,\ V_{D}=12\ V,\\ R_{GK}=1\ k\Omega \end{array}$
Thermal resistance	R <sub>th (j-a)</sub>	_	_	500	°C/W	Junction to ambient

# **Package Dimensions**



### **Order Code**

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Surface-mounted type	Taping	3000	Type name – T +Direction (1 or 2) +3	CR05BS-8-T13

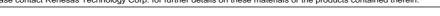
Note : Please confirm the specification about the shipping in detail.

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